

SNx4LV02A Quadruple 2-Input Positive-NOR Gates

1 Features

- 2-V to 5.5-V  $V_{CC}$  Operation
- Max  $t_{pd}$  of 6.5 ns at 5 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  
 $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^{\circ}\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  
 $> 2.3$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^{\circ}\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- $I_{off}$  Supports Live insertion, Partial Power Down Mode, and Back Drive Protection
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model
  - 200-V Machine Model
  - 1000-V Charged-Device Model

2 Applications

- Handset: Smartphone
- Network Switch
- Health & Fitness / Wearables
- PDAs
- TV (LCD)
- Power Infrastructure

3 Description

The SNx4LV02A devices are quadruple 2-input positive-NOR gates designed for 2-V to 5.5-V  $V_{CC}$  operation.

The SNx4LV02A devices perform the Boolean function  $Y = \overline{A + B}$  or  $Y = \overline{A} \bullet \overline{B}$  in positive logic.

Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM)    |
|-------------|------------|--------------------|
| SNx4LV02A   | VQFN (14)  | 3.50 mm x 3.50 mm  |
|             | SOIC (14)  | 8.65 mm x 3.91 mm  |
|             | SOP (14)   | 10.30 mm x 5.30 mm |
|             | SSOP (14)  | 6.20 mm x 5.30 mm  |
|             | TSSOP (14) | 5.00 mm x 4.40 mm  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

4 Simplified Schematic



## Table of Contents

|                                                                               |          |                                                                  |           |
|-------------------------------------------------------------------------------|----------|------------------------------------------------------------------|-----------|
| <b>1 Features</b> .....                                                       | <b>1</b> | <b>9 Detailed Description</b> .....                              | <b>9</b>  |
| <b>2 Applications</b> .....                                                   | <b>1</b> | 9.1 Overview .....                                               | 9         |
| <b>3 Description</b> .....                                                    | <b>1</b> | 9.2 Functional Block Diagram .....                               | 9         |
| <b>4 Simplified Schematic</b> .....                                           | <b>1</b> | 9.3 Feature Description .....                                    | 9         |
| <b>5 Revision History</b> .....                                               | <b>2</b> | 9.4 Device Functional Modes .....                                | 9         |
| <b>6 Pin Configuration and Functions</b> .....                                | <b>3</b> | <b>10 Application and Implementation</b> .....                   | <b>10</b> |
| <b>7 Specifications</b> .....                                                 | <b>4</b> | 10.1 Application Information .....                               | 10        |
| 7.1 Absolute Maximum Ratings .....                                            | 4        | 10.2 Typical Application .....                                   | 10        |
| 7.2 ESD Ratings .....                                                         | 4        | <b>11 Power Supply Recommendations</b> .....                     | <b>11</b> |
| 7.3 Recommended Operating Conditions .....                                    | 5        | <b>12 Layout</b> .....                                           | <b>12</b> |
| 7.4 Thermal Information .....                                                 | 5        | 12.1 Layout Guidelines .....                                     | 12        |
| 7.5 Electrical Characteristics .....                                          | 6        | 12.2 Layout Example .....                                        | 12        |
| 7.6 Switching Characteristics, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ ..... | 6        | <b>13 Device and Documentation Support</b> .....                 | <b>12</b> |
| 7.7 Switching Characteristics, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ ..... | 6        | 13.1 Related Links .....                                         | 12        |
| 7.8 Switching Characteristics, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ .....   | 6        | 13.2 Trademarks .....                                            | 12        |
| 7.9 Noise Characteristics .....                                               | 7        | 13.3 Electrostatic Discharge Caution .....                       | 12        |
| 7.10 Operating Characteristics .....                                          | 7        | 13.4 Glossary .....                                              | 12        |
| 7.11 Typical Characteristics .....                                            | 7        | <b>14 Mechanical, Packaging, and Orderable Information</b> ..... | <b>13</b> |
| <b>8 Parameter Measurement Information</b> .....                              | <b>8</b> |                                                                  |           |

## 5 Revision History

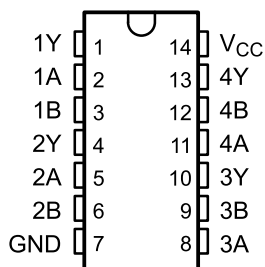
### Changes from Revision I (April 2005) to Revision K

Page

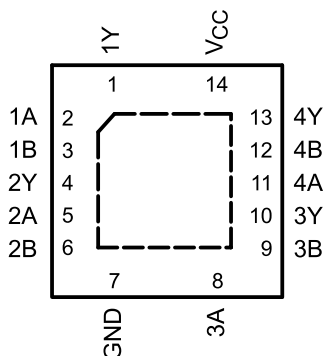
- Added *Applications*, *Device Information* table, *Pin Functions* table, *ESD Ratings* table, *Thermal Information* table, *Typical Characteristics*, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section. .... **1**

## 6 Pin Configuration and Functions

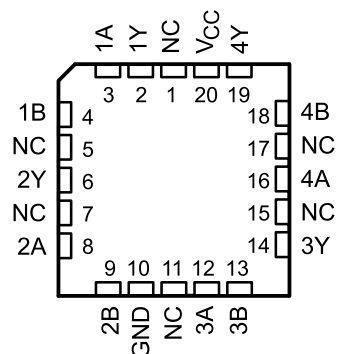
**SN54LV02A . . . J OR W PACKAGE  
SN74LV02A . . . D, DB, DGV, NS,  
OR PW PACKAGE  
(TOP VIEW)**



**SN74LV02A . . . RGY PACKAGE  
(TOP VIEW)**



**SN54LV02A . . . FK PACKAGE  
(TOP VIEW)**



NC - No internal Connection

### Pin Functions

| PIN |                 | TYPE | DESCRIPTION     |
|-----|-----------------|------|-----------------|
| NO. | NAME            |      |                 |
| 1   | 1Y              | O    | 1Y output       |
| 2   | 1A              | I    | 1A input        |
| 3   | 1B              | I    | 1B input        |
| 4   | 2Y              | O    | 2Y output       |
| 5   | 2A              | I    | 2A input        |
| 6   | 2B              | I    | 2B input        |
| 7   | GND             | —    | GND             |
| 8   | 3A              | I    | 3A input        |
| 9   | 3B              | I    | 3B input        |
| 10  | 3Y              | O    | 3Y output       |
| 11  | 4A              | I    | 4A input        |
| 12  | 4B              | I    | 4B input        |
| 13  | 4Y              | O    | 4Y output       |
| 14  | V <sub>CC</sub> | —    | V <sub>CC</sub> |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|           |                                                                                             | MIN                   | MAX            | UNIT |
|-----------|---------------------------------------------------------------------------------------------|-----------------------|----------------|------|
| $V_{CC}$  | Supply voltage range                                                                        | –0.5                  | 7              | V    |
| $V_I$     | Input voltage range <sup>(2)</sup>                                                          | –0.5                  | 7              | V    |
| $V_O$     | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | –0.5                  | 7              | V    |
| $V_O$     | Output voltage range <sup>(2)(3)</sup>                                                      | –0.5                  | $V_{CC} + 0.5$ | V    |
| $I_{IK}$  | Input clamp current                                                                         | $V_I < 0$             | –20            | mA   |
| $I_{OK}$  | Output clamp current                                                                        | $V_O < 0$             | –50            | mA   |
| $I_O$     | Continuous output current                                                                   | $V_O = 0$ to $V_{CC}$ | ±25            | mA   |
|           | Continuous current through $V_{CC}$ or GND                                                  |                       | ±50            | mA   |
| $T_{stg}$ | Storage temperature range                                                                   | –65                   | 150            | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) This value is limited to 5.5-V maximum.

### 7.2 ESD Ratings

|             |                         | VALUE                                                                                    | UNIT  |
|-------------|-------------------------|------------------------------------------------------------------------------------------|-------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>              | ±1500 |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup> | ±2000 |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                                    |                                  | SN54LV02A <sup>(2)</sup> |                       | SN74LV02A             |                       | UNIT |
|-----------------|------------------------------------|----------------------------------|--------------------------|-----------------------|-----------------------|-----------------------|------|
|                 |                                    |                                  | MIN                      | MAX                   | MIN                   | MAX                   |      |
| V <sub>CC</sub> | Supply voltage                     |                                  | 2                        | 5.5                   | 2                     | 5.5                   | V    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 2 V            | 1.5                      |                       | 1.5                   |                       | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V | V <sub>CC</sub> × 0.7    |                       | V <sub>CC</sub> × 0.7 |                       |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   | V <sub>CC</sub> × 0.7    |                       | V <sub>CC</sub> × 0.7 |                       |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V | V <sub>CC</sub> × 0.7    |                       | V <sub>CC</sub> × 0.7 |                       |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 2 V            |                          | 0.5                   |                       | 0.5                   | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V |                          | V <sub>CC</sub> × 0.3 |                       | V <sub>CC</sub> × 0.3 |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   |                          | V <sub>CC</sub> × 0.3 |                       | V <sub>CC</sub> × 0.3 |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V |                          | V <sub>CC</sub> × 0.3 |                       | V <sub>CC</sub> × 0.3 |      |
| V <sub>I</sub>  | Input voltage                      |                                  | 0                        | 5.5                   | 0                     | 5.5                   | V    |
| V <sub>O</sub>  | Output voltage                     |                                  | 0                        | 5.5                   | 0                     | 5.5                   | V    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 2 V            |                          | –50                   |                       | –50                   | μA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V |                          | –2                    |                       | –2                    |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   |                          | –6                    |                       | –6                    |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V |                          | –12                   |                       | –12                   |      |
| I <sub>IH</sub> | Low-level output current           | V <sub>CC</sub> = 2 V            |                          | 50                    |                       | 50                    | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V |                          | 2                     |                       | 2                     |      |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   |                          | 6                     |                       | 6                     |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V |                          | 12                    |                       | 12                    |      |
| Δt/Δv           | Input transition rise or fall rate | V <sub>CC</sub> = 2.3 V to 2.7 V |                          | 200                   |                       | 200                   | ns/V |
|                 |                                    | V <sub>CC</sub> = 3 V to 3.6 V   |                          | 100                   |                       | 100                   |      |
|                 |                                    | V <sub>CC</sub> = 4.5 V to 5.5 V |                          | 20                    |                       | 20                    |      |
| T <sub>A</sub>  | Operating free-air temperature     |                                  | –55                      | 125                   | –40                   | 125                   | °C   |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs* (SCBA004).

(2) Product Preview.

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | SN74LV02A |         |         |         |         |         | UNIT |
|-------------------------------|----------------------------------------------|-----------|---------|---------|---------|---------|---------|------|
|                               |                                              | D         | DB      | DGV     | NS      | PW      | RGY     |      |
|                               |                                              | 14 PINS   | 14 PINS | 14 PINS | 14 PINS | 14 PINS | 14 PINS |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 97.5      | 109.5   | 133.3   | 92.2    | 125.1   | 59.0    | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 58.7      | 62.1    | 55.6    | 49.8    | 53.7    | 72.5    |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 51.8      | 56.9    | 66.3    | 51.0    | 66.9    | 35.0    |      |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 22.6      | 22.6    | 7.8     | 15.7    | 7.6     | 3.9     |      |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 51.6      | 56.3    | 56.6    | 50.6    | 66.3    | 35.1    |      |
| R <sub>θJC(bot)</sub>         |                                              | –         | –       | –       | –       | –       | 15.4    |      |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report (SPRA953).

## SN54LV02A, SN74LV02A

SCLS390K – APRIL 1998 – REVISED FEBRUARY 2015

www.ti.com

### 7.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS                                             | V <sub>CC</sub> | SN54LV02A <sup>(1)</sup> |     |      | –40°C to 85°C<br>SN74LV02A |      | –40°C to 125°C<br>SN74LV02A |      | UNIT |
|------------------|-------------------------------------------------------------|-----------------|--------------------------|-----|------|----------------------------|------|-----------------------------|------|------|
|                  |                                                             |                 | MIN                      | TYP | MAX  | MIN                        | MAX  | MIN                         | MAX  |      |
| V <sub>OH</sub>  | I <sub>OL</sub> = –50 µA                                    | 2 V to 5.5 V    | V <sub>CC</sub> – 0.1    |     |      | V <sub>CC</sub> – 0.1      |      | V <sub>CC</sub> – 0.1       |      |      |
|                  | I <sub>OL</sub> = –2 mA                                     | 2.3 V           | 2                        |     |      | 2                          |      | 2                           |      |      |
|                  | I <sub>OL</sub> = –6 mA                                     | 3 V             | 2.48                     |     |      | 2.48                       |      | 2.48                        |      |      |
|                  | I <sub>OL</sub> = –12 mA                                    | 4.5 V           | 3.8                      |     |      | 3.8                        |      | 3.8                         |      |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 50 µA                                     | 2 V to 5.5 V    |                          |     | 0.1  |                            | 0.1  |                             | 0.1  | V    |
|                  | I <sub>OL</sub> = 2 mA                                      | 2.3 V           |                          |     | 0.4  |                            | 0.4  |                             | 0.4  |      |
|                  | I <sub>OL</sub> = 6 mA                                      | 3 V             |                          |     | 0.44 |                            | 0.44 |                             | 0.44 |      |
|                  | I <sub>OL</sub> = 12 mA                                     | 4.5 V           |                          |     | 0.55 |                            | 0.55 |                             | 0.55 |      |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or GND                               | 0 to 5.5 V      |                          |     | ±1   |                            | ±1   |                             | ±1   | µA   |
| I <sub>CC</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0 | 5.5             |                          |     | 20   |                            | 20   |                             | 20   | µA   |
| I <sub>off</sub> | V <sub>I</sub> or V <sub>O</sub> = 0 to 5.5 V               | 0               |                          |     | 5    |                            | 5    |                             | 5    | µA   |
| C <sub>i</sub>   | V <sub>I</sub> = V <sub>CC</sub> or GND                     | 3.3 V           |                          | 1.6 |      |                            | 1.6  |                             | 1.6  | pF   |

(1) Product Preview.

### 7.6 Switching Characteristics, V<sub>CC</sub> = 2.5 V ± 0.2 V

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER       | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE       | T <sub>A</sub> = 25°C |                    |                     | SN54LV02A        |                   | –40°C to 85°C<br>SN74LV02A |     | –40°C to 125°C<br>SN74LV02A |      | UNIT |
|-----------------|--------------|-------------|------------------------|-----------------------|--------------------|---------------------|------------------|-------------------|----------------------------|-----|-----------------------------|------|------|
|                 |              |             |                        | MIN                   | TYP                | MAX                 | MIN              | MAX               | MIN                        | MAX | MIN                         | MAX  |      |
| t <sub>pd</sub> | A or B       | Y           | C <sub>L</sub> = 15 pF |                       | 8.3 <sup>(1)</sup> | 12.4 <sup>(1)</sup> | 1 <sup>(1)</sup> | 15 <sup>(1)</sup> | 1                          | 15  | 1                           | 17.5 | ns   |
|                 |              |             | C <sub>L</sub> = 50 pF |                       | 11 <sup>(1)</sup>  | 16.1 <sup>(1)</sup> | 1                | 19                | 1                          | 19  | 1                           | 21.5 |      |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

### 7.7 Switching Characteristics, V<sub>CC</sub> = 3.3 V ± 0.3 V

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER       | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE       | T <sub>A</sub> = 25°C |                    |                     | SN54LV02A        |                    | –40°C to 85°C<br>SN74LV02A |     | –40°C to 125°C<br>SN74LV02A |      | UNIT |
|-----------------|--------------|-------------|------------------------|-----------------------|--------------------|---------------------|------------------|--------------------|----------------------------|-----|-----------------------------|------|------|
|                 |              |             |                        | MIN                   | TYP                | MAX                 | MIN              | MAX                | MIN                        | MAX | MIN                         | MAX  |      |
| t <sub>pd</sub> | A or B       | Y           | C <sub>L</sub> = 15 pF |                       | 5.6 <sup>(1)</sup> | 7.9 <sup>(1)</sup>  | 1 <sup>(1)</sup> | 9.5 <sup>(1)</sup> | 1                          | 9.5 | 1                           | 11.5 | ns   |
|                 |              |             | C <sub>L</sub> = 50 pF |                       | 7.6 <sup>(1)</sup> | 11.4 <sup>(1)</sup> | 1                | 13                 | 1                          | 13  | 1                           | 15   |      |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

### 7.8 Switching Characteristics, V<sub>CC</sub> = 5 V ± 0.5 V

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER       | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE       | T <sub>A</sub> = 25°C |                    |                    | SN54LV02A        |                    | –40°C to 85°C<br>SN74LV02A |     | –40°C to 125°C<br>SN74LV02A |     | UNIT |
|-----------------|--------------|-------------|------------------------|-----------------------|--------------------|--------------------|------------------|--------------------|----------------------------|-----|-----------------------------|-----|------|
|                 |              |             |                        | MIN                   | TYP                | MAX                | MIN              | MAX                | MIN                        | MAX | MIN                         | MAX |      |
| t <sub>pd</sub> | A or B       | Y           | C <sub>L</sub> = 15 pF |                       | 3.9 <sup>(1)</sup> | 5.5 <sup>(1)</sup> | 1 <sup>(1)</sup> | 6.5 <sup>(1)</sup> | 1                          | 6.5 | 1                           | 8   | ns   |
|                 |              |             | C <sub>L</sub> = 50 pF |                       | 5.3 <sup>(1)</sup> | 7.5 <sup>(1)</sup> | 1                | 8.5                | 1                          | 8.5 | 1                           | 10  |      |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

## 7.9 Noise Characteristics<sup>(1)</sup>

$V_{CC} = 3.3\text{ V}$ ,  $C_L = 50\text{ pF}$ ,  $T_A = 25^\circ\text{C}$

| PARAMETER                                          | SN74LV02A |      |      | UNIT |
|----------------------------------------------------|-----------|------|------|------|
|                                                    | MIN       | TYP  | MAX  |      |
| $V_{OL(P)}$ Quiet output, maximum dynamic $V_{OL}$ |           | 0.2  | 0.8  | V    |
| $V_{OL(V)}$ Quiet output, minimum dynamic $V_{OL}$ |           | –0.1 | –0.8 | V    |
| $V_{OH(V)}$ Quiet output, minimum dynamic $V_{OH}$ |           | 3.2  |      | V    |
| $V_{IH(D)}$ High-level dynamic input voltage       | 2.31      |      |      | V    |
| $V_{IL(D)}$ Low-level dynamic input voltage        |           |      | 0.99 | V    |

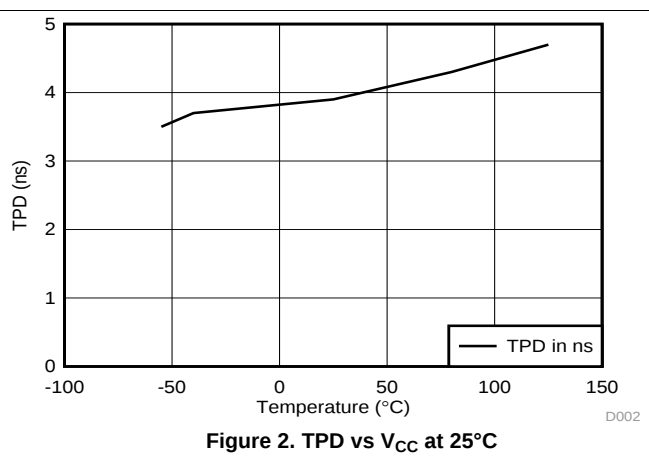
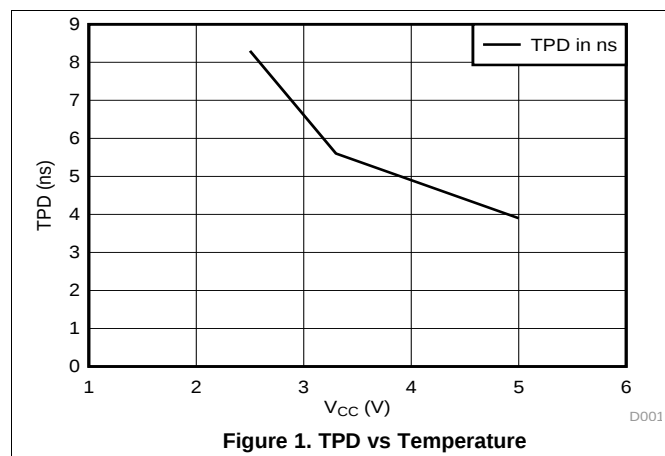
(1) Characteristics are for surface-mount packages only.

## 7.10 Operating Characteristics

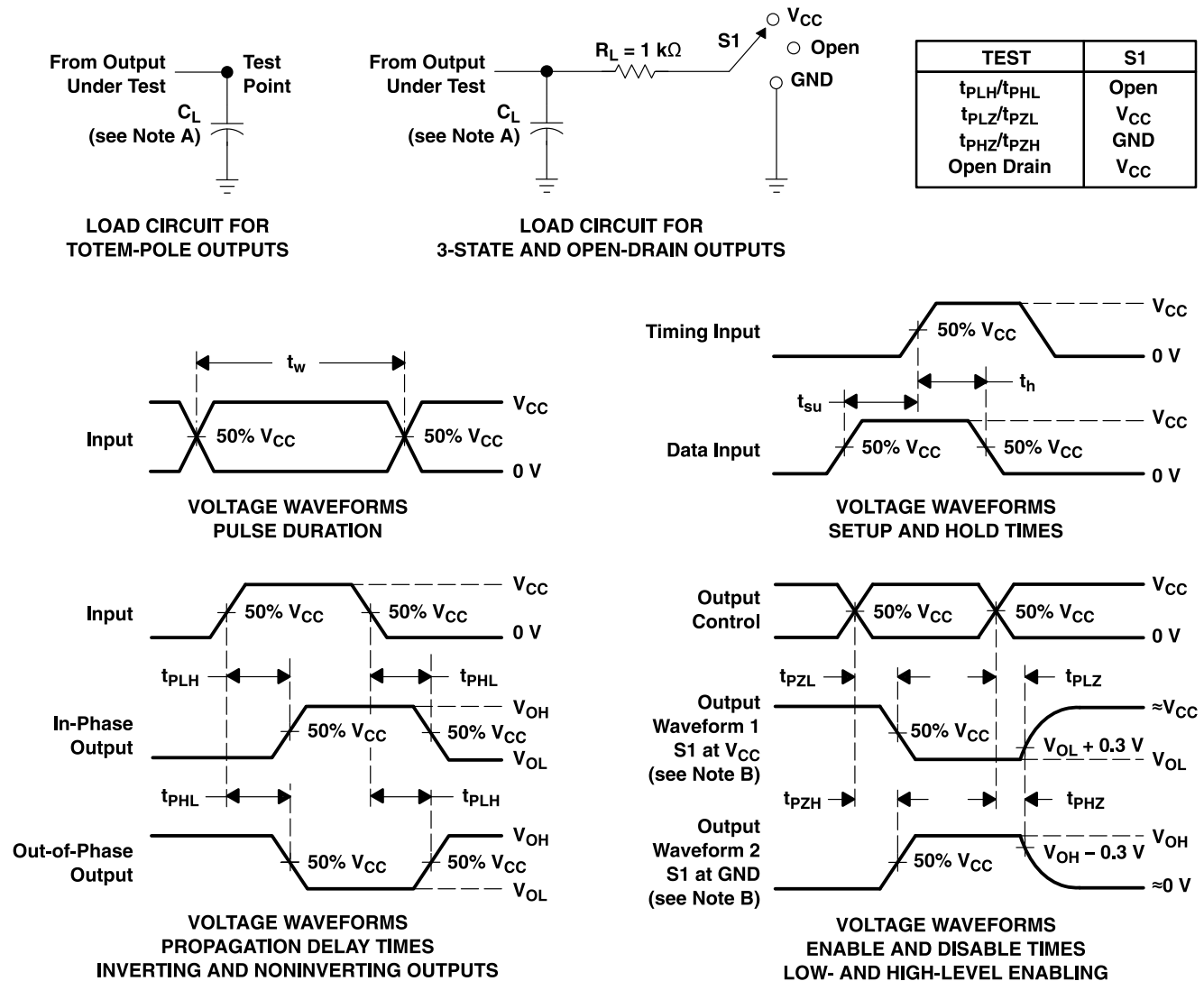
$T_A = 25^\circ\text{C}$

| PARAMETER                              | TEST CONDITIONS                            | $V_{CC}$ | TYP | UNIT |
|----------------------------------------|--------------------------------------------|----------|-----|------|
| $C_{pd}$ Power dissipation capacitance | $C_L = 50\text{ pF}$ , $f = 10\text{ MHz}$ | 3.3 V    | 8.9 | pF   |
|                                        |                                            | 5 V      | 3   |      |

## 7.11 Typical Characteristics



## 8 Parameter Measurement Information



- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 3\text{ ns}$ ,  $t_f \leq 3\text{ ns}$ .
  - The outputs are measured one at a time, with one input transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PHL}$  and  $t_{PLH}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

**Figure 3. Load Circuit and Voltage Waveforms**

## 9 Detailed Description

### 9.1 Overview

The SN74LV02A devices are quadruple 2-input positive-NOR gates designed for 2-V to 5.5-V  $V_{CC}$  operation.

The SN74LV02A devices perform the Boolean function  $Y = \overline{A + B}$  or  $Y = \overline{A} \bullet \overline{B}$  in positive logic.

These devices are fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

### 9.2 Functional Block Diagram



**Figure 4. Logic Diagram (Positive Logic)**

### 9.3 Feature Description

- Wide operating voltage range
  - Operates from 2 V to 5.5 V
- Allows down voltage translation
  - Inputs accept voltages to 5.5 V
- $I_{off}$  feature allows voltages on the inputs and outputs when  $V_{CC}$  is 0 V

### 9.4 Device Functional Modes

**Table 1. Function Table  
(Each Gate)**

| INPUT |   | OUTPUT<br>Y |
|-------|---|-------------|
| A     | B |             |
| H     | X | L           |
| X     | H | L           |
| L     | L | H           |

## 10 Application and Implementation

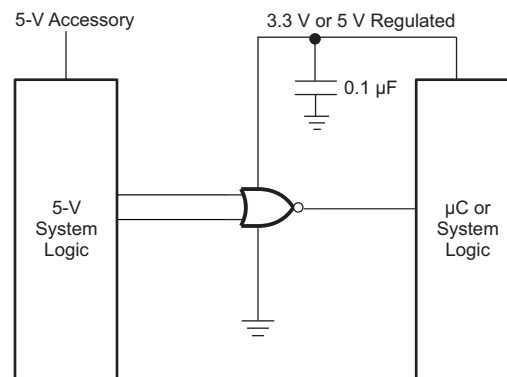
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

The SN74LV02A is a Low drive CMOS device that can be used for a multitude of bus interface type applications where output ringing is a concern. The low drive and slow edge rates will minimize overshoot and undershoot on the outputs. The inputs can accept voltages to 5.5 V at any valid  $V_{CC}$  making it Ideal for down translation.

### 10.2 Typical Application



**Figure 5. Typical Application Schematic**

#### 10.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Care should be taken to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads so routing and load conditions should be considered to prevent ringing.

#### 10.2.2 Detailed Design Procedure

1. Recommended Input Conditions
  - For specified High and low levels, see  $V_{IH}$  and  $V_{IL}$  in the [Recommended Operating Conditions](#) table.
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid  $V_{CC}$ .
2. Recommend Output Conditions
  - Load currents should not exceed 25 mA per output and 50 mA total for the part.
  - Outputs should not be pulled above  $V_{CC}$ .

## Typical Application (continued)

### 10.2.3 Application Curves

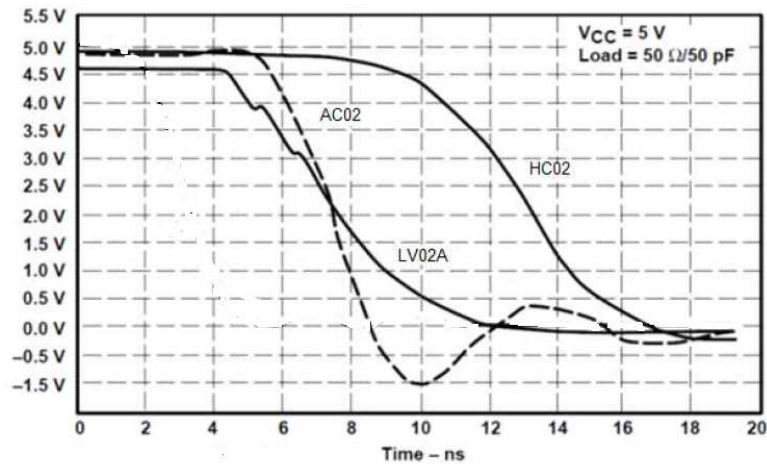


Figure 6. Typical Application Curve

## 11 Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the [Recommended Operating Conditions](#) table.

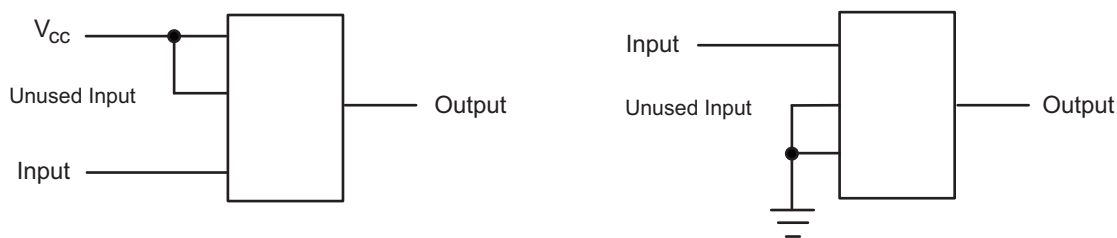
Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, a 0.1  $\mu\text{F}$  capacitor is recommended and if there are multiple  $V_{CC}$  terminals then .01  $\mu\text{F}$  or .022  $\mu\text{F}$  capacitor is recommended for each power terminal. It is ok to parallel multiple bypass capacitors to reject different frequencies of noise. 0.1  $\mu\text{F}$  and 1  $\mu\text{F}$  capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

## 12 Layout

### 12.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float. In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$  whichever make more sense or is more convenient. It is generally OK to float outputs unless the part is a transceiver. If the transceiver has an output enable pin it will disable the outputs section of the part when asserted. This will not disable the input section of the I.O's so they also cannot float when disabled.

### 12.2 Layout Example



**Figure 7. Layout Diagram**

## 13 Device and Documentation Support

### 13.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

| PARTS     | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|-----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| SN74LV02A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 13.2 Trademarks

All trademarks are the property of their respective owners.

### 13.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number         | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74LV02AD</a>    | Obsolete      | Production           | SOIC (D)   14    | -                     | -           | Call TI                              | Call TI                           | -40 to 125   | LV02A               |
| <a href="#">SN74LV02ADBR</a>  | Active        | Production           | SSOP (DB)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ADBR.A                | Active        | Production           | SSOP (DB)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ADBRE4                | Active        | Production           | SSOP (DB)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| <a href="#">SN74LV02ADGVR</a> | Active        | Production           | TVSOP (DGV)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ADGVR.A               | Active        | Production           | TVSOP (DGV)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| <a href="#">SN74LV02ADR</a>   | Active        | Production           | SOIC (D)   14    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ADR.A                 | Active        | Production           | SOIC (D)   14    | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ADR.B                 | Active        | Production           | SOIC (D)   14    | 2500   LARGE T&R      | -           | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| <a href="#">SN74LV02ANSR</a>  | Active        | Production           | SOP (NS)   14    | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 74LV02A             |
| SN74LV02ANSR.A                | Active        | Production           | SOP (NS)   14    | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 74LV02A             |
| <a href="#">SN74LV02APW</a>   | Obsolete      | Production           | TSSOP (PW)   14  | -                     | -           | Call TI                              | Call TI                           | -40 to 125   | LV02A               |
| <a href="#">SN74LV02APWR</a>  | Active        | Production           | TSSOP (PW)   14  | 2000   LARGE T&R      | Yes         | NIPDAU   SN                          | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02APWR.A                | Active        | Production           | TSSOP (PW)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02APWR.B                | Active        | Production           | TSSOP (PW)   14  | 2000   LARGE T&R      | -           | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02APWRG4.A              | Active        | Production           | TSSOP (PW)   14  | 2000   null           | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02APWRG4.A              | Active        | Production           | TSSOP (PW)   14  | 2000   null           | No          | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| <a href="#">SN74LV02APWT</a>  | Obsolete      | Production           | TSSOP (PW)   14  | -                     | -           | Call TI                              | Call TI                           | -40 to 125   | LV02A               |
| <a href="#">SN74LV02ARGYR</a> | Active        | Production           | VQFN (RGY)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ARGYR.A               | Active        | Production           | VQFN (RGY)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ARGYRG4               | Active        | Production           | VQFN (RGY)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |
| SN74LV02ARGYRG4.A             | Active        | Production           | VQFN (RGY)   14  | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LV02A               |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LV02ADBR    | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| SN74LV02ADGVR   | TVSOP        | DGV             | 14   | 2000 | 330.0              | 12.4               | 6.8     | 4.0     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LV02ADR     | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LV02ANSR    | SOP          | NS              | 14   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| SN74LV02APWR    | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LV02ARGYR   | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |
| SN74LV02ARGYRG4 | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV02ADBR    | SSOP         | DB              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LV02ADGVR   | TVSOP        | DGV             | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74LV02ADR     | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN74LV02ANSR    | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LV02APWR    | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LV02ARGYR   | VQFN         | RGY             | 14   | 3000 | 360.0       | 360.0      | 36.0        |
| SN74LV02ARGYRG4 | VQFN         | RGY             | 14   | 3000 | 360.0       | 360.0      | 36.0        |

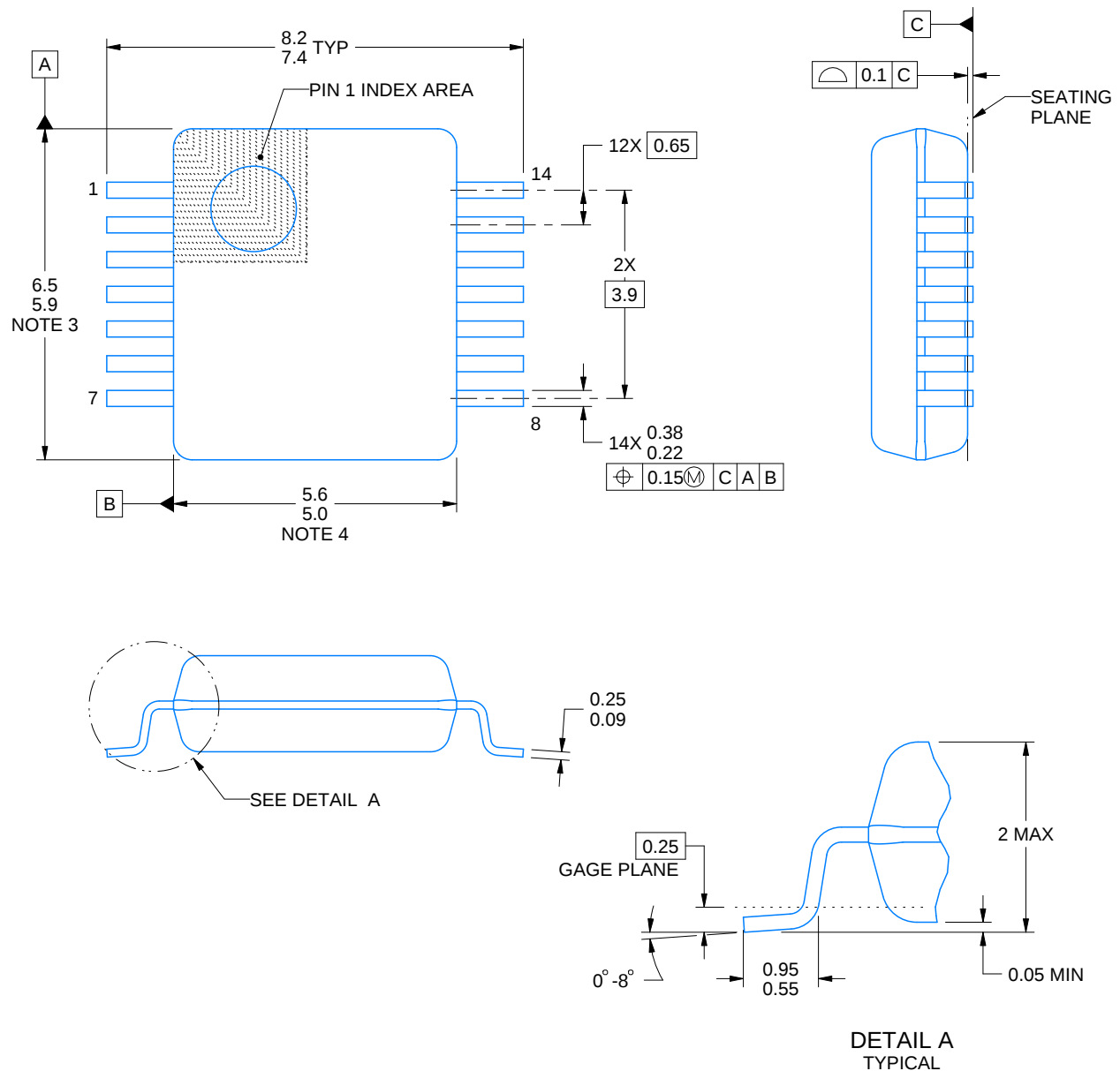
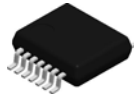
## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194



4220762/A 05/2024

## NOTES:

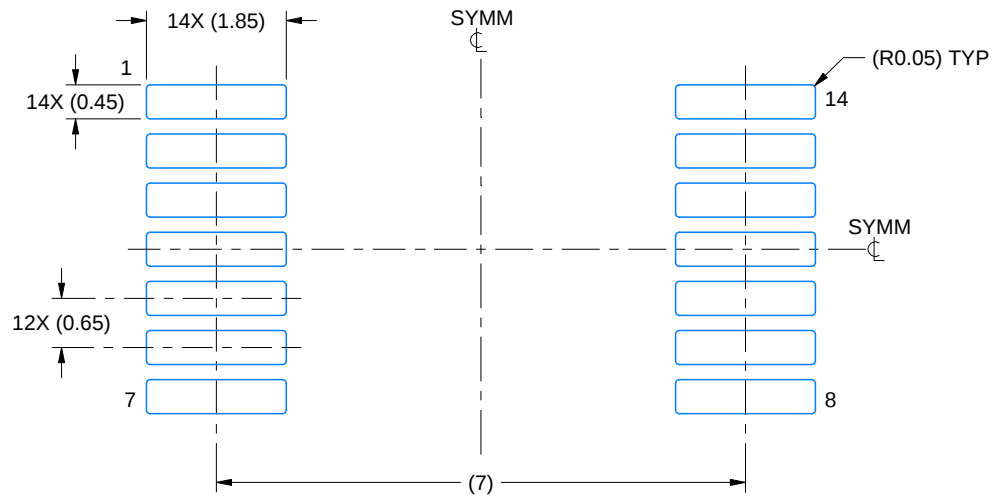
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

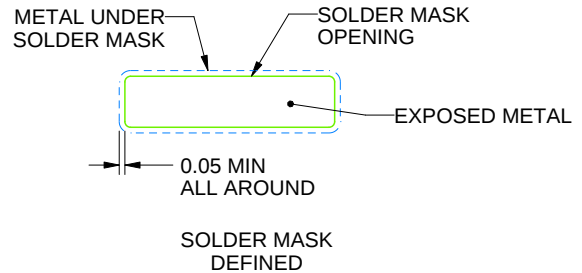
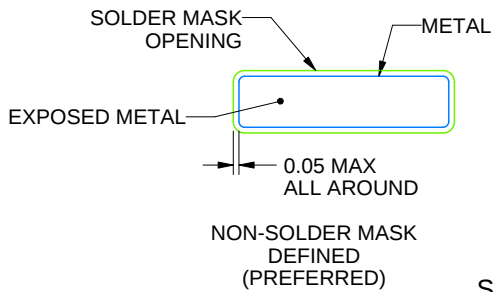
DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220762/A 05/2024

NOTES: (continued)

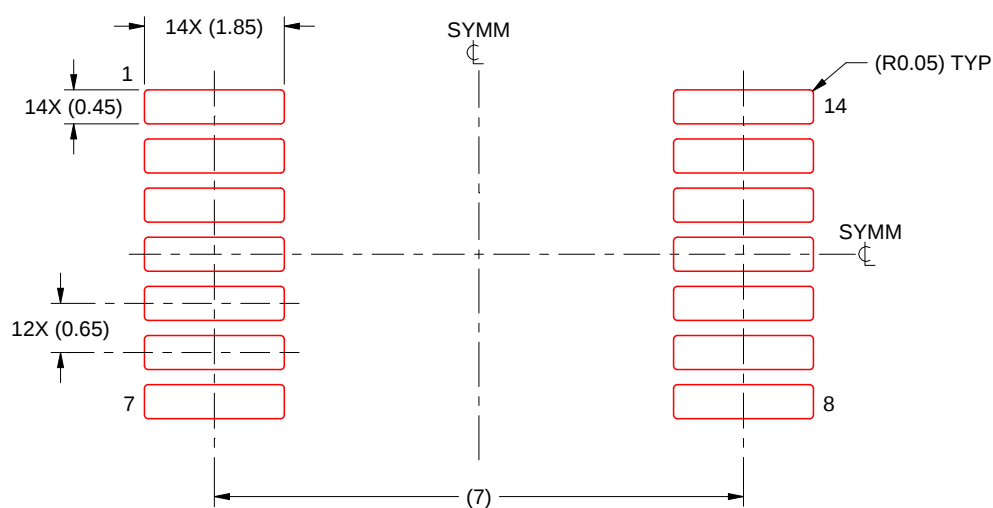
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220762/A 05/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.



# EXAMPLE BOARD LAYOUT

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220202/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

**D0014A****PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

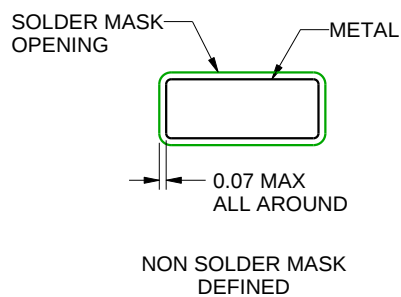
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## GENERIC PACKAGE VIEW

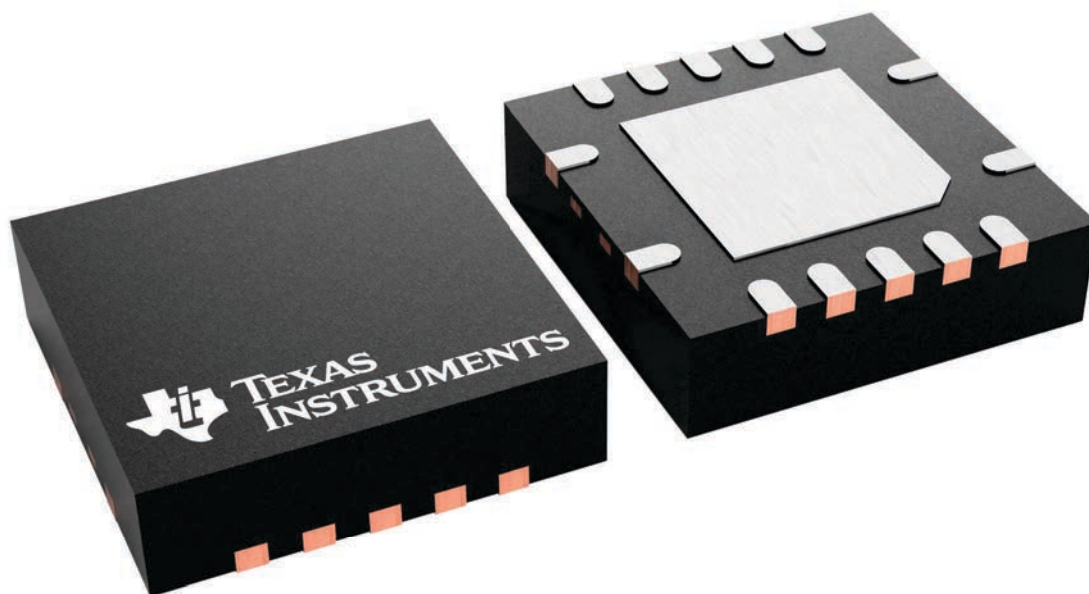
**RGY 14**

**VQFN - 1 mm max height**

3.5 x 3.5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4231541/A



### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

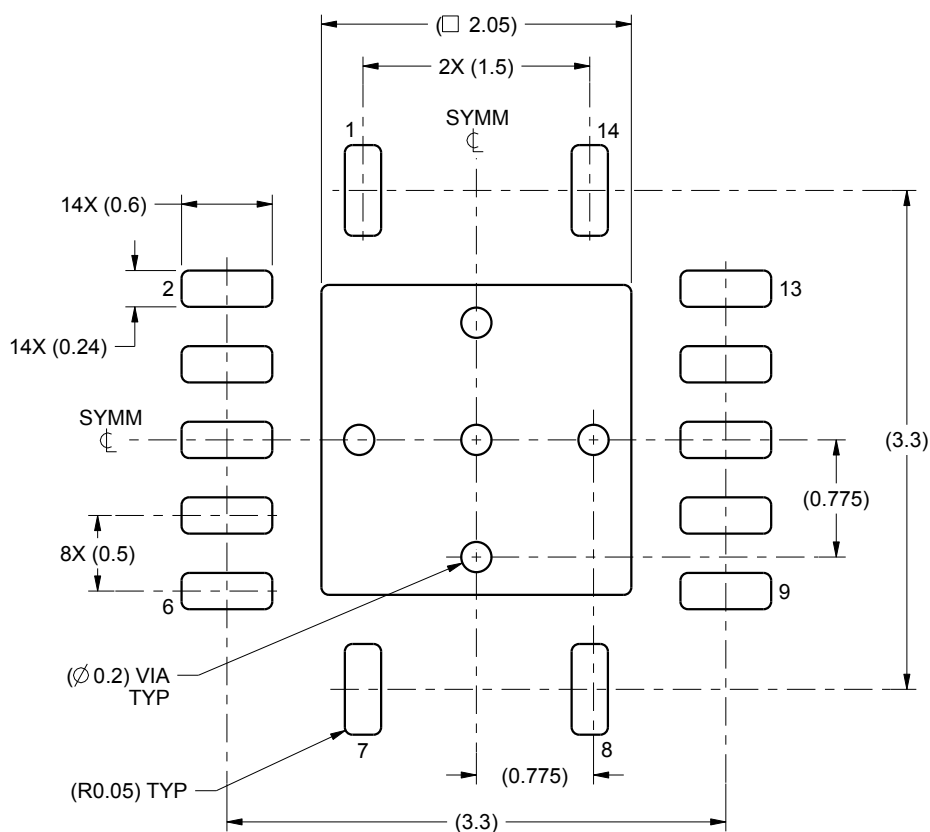


1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

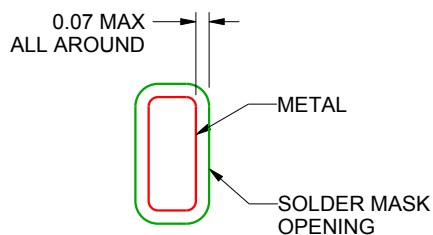
**RGY0014A**

## VQFN - 1 mm max height

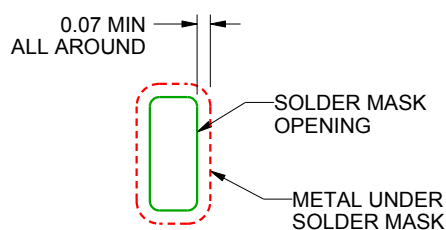
PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:20X



NON SOLDER MASK  
DEFINED  
(PREFERRED)



SOLDER MASK  
DEFINED

## SOLDER MASK DETAILS

4219040/A 09/2015

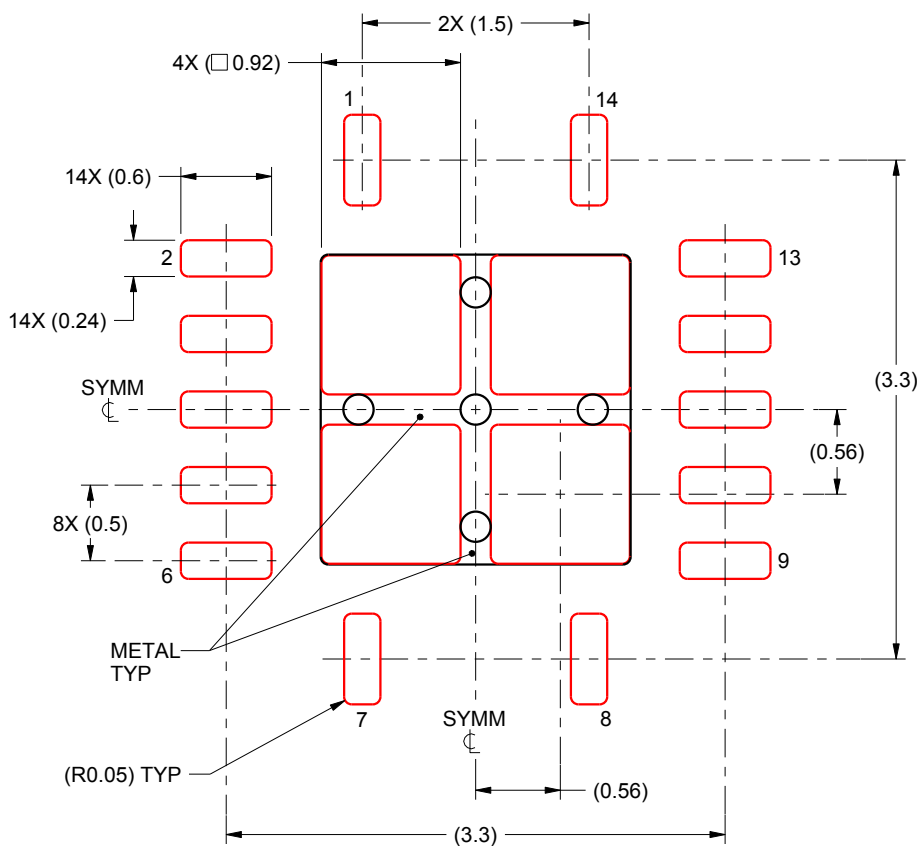
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).

**RGY0014A**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
**BASED ON 0.125 mm THICK STENCIL**

**EXPOSED PAD**  
**80% PRINTED SOLDER COVERAGE BY AREA**  
**SCALE:20X**

4219040/A 09/2015

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2025, Texas Instruments Incorporated